

MPEG Clock Generator with VCXO

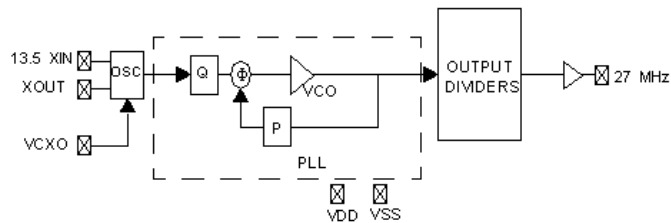
Features

- Integrated Phase-Locked Loop (PLL)
- Low Jitter, High Accuracy Outputs
- VCXO with Analog Adjust
- 3.3V Operation
- Compatible with MK3727 (-1, -4)
- Application compatibility for a wide variety of Designs
- Enables Design compatibility
- Lower Drive Strength settings (CY241V08A-04)

Benefits

- Digital VCXO control
- Second source for existing designs
- Highest performance PLL tailored for multimedia applications
- Meets critical timing requirements in complex system designs

CY241V08A-01, -04 Logic Block Diagram

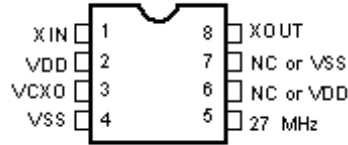


Selector Guide

Part Number	Outputs	Input Frequency Range	Output Frequencies	VCXO Control Curve	Other Features
CY241V08A-01	1	13.5 MHz pullable crystal input according to Cypress specification	1 copy of 27 MHz	linear	Compatible with MK3727
CY241V08A-04	1	13.5 MHz pullable crystal input according to Cypress specification	1 copy of 27 MHz	linear	Same as CY241V08A-01 except lower drive strength settings

Pin Configurations

Figure 1. CY241V08A-01, -04 8-Pin SOIC



Pin Descriptions

Name	Pin Number	Description
XIN	1	Reference crystal input
VDD	2	Voltage supply
VCXO	3	Input analog control for VCXO
VSS	4	Ground
27 MHz	5	27 MHz clock output
NC/VDD	6	No connect or voltage supply
NC/VSS	7	No connect or ground
XOUT	8	Reference crystal output

Absolute Maximum Conditions

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Supply Voltage (V_{DD}).....-0.5 to +7.0V
 DC Input Voltage-0.5V to $V_{DD} + 0.5$
 Storage Temperature (Non-condensing) -55°C to +125°C

Junction Temperature..... -40°C to +125°C
 Data Retention at $T_j = 125^\circ\text{C}$ > 10 years
 Package Power Dissipation..... 350 mW
 ESD (Human Body Model) MIL-STD-883..... > 2000V

Pullable Crystal Specifications^[1]

Parameter	Description	Comments	Min	Typ	Max	Unit
F_{NOM}	Nominal crystal frequency	Parallel resonance, fundamental mode, AT cut	-	13.5	-	MHz
C_{LNOM}	Nominal load capacitance		-	14	-	pF
R_1	Equivalent series resistance (ESR)	Fundamental mode	-	-	25	Ω
R_3/R_1	Ratio of third overtone mode ESR to fundamental mode ESR	Ratio used because typical R_1 values are much less than the maximum spec	3	-	-	-
DL	Crystal drive level	No external series resistor assumed	150	-	-	μW
F_{3SEPHI}	Third overtone separation from $3 \cdot F_{NOM}$	High side	300	-	-	ppm
F_{3SEPLO}	Third overtone separation from $3 \cdot F_{NOM}$	Low side	-	-	-150	ppm
C_0	Crystal shunt capacitance		-	-	7	pF
C_0/C_1	Ratio of shunt to motional capacitance		180	-	250	-
C_1	Crystal motional capacitance		14.4	18	21.6	fF

Recommended Operating Conditions

Parameter	Description	Min	Typ	Max	Unit
V_{DD}	Operating Voltage	3.135	3.3	3.465	V
T_A	Ambient Temperature	0	-	70	$^\circ\text{C}$
C_{LOAD}	Maximum Load Capacitance	-	-	15	pF
t_{PU}	Power up time for all VDD pins to reach minimum specified voltage (power ramps must be monotonic)	0.05	-	500	ms

DC Electrical Specifications

Parameter	Name	Description	Min	Typ	Max	Unit
I_{OH}	Output HIGH Current	$V_{OH} = V_{DD} - 0.5\text{V}$, $V_{DD} = 3.3\text{V}$	12	24	-	mA
I_{OL}	Output LOW Current	$V_{OL} = 0.5\text{V}$, $V_{DD} = 3.3\text{V}$	12	24	-	mA
C_{IN}	Input Capacitance	Except XIN, XOUT pins	-	-	7	pF
V_{VCXO}	VCXO Input Range		0	-	V_{DD}	V
$f_{\Delta XO}^{[2]}$	VCXO Pullability Range	Low Side	-	-	-115	ppm
		High Side	115	-	-	ppm
I_{VDD}	Supply Current		-	30	35	mA

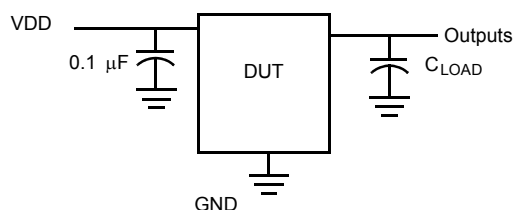
Notes

- Crystals that meet this specification include: Ecliptek ECX-5788-13.500M, Siward XTL001050A-13.5-14-400, Raltron A-13.500-14-CL, PDI HA13500XFSA14XC.
- 115/+115 ppm assumes 2.5 pF of additional board level load capacitance. This range will be shifted down with more board capacitance or shifted up with less board capacitance.

AC Electrical Specifications ($V_{DD} = 3.3V$)^[3]

Parameter ^[3]	Name	Description	Min	Typ	Max	Unit
DC	Output Duty Cycle	Duty Cycle is defined in Figure 2, 50% of V_{DD}	45	50	55	%
ER _{OR}	Rising Edge Rate -01	Output Clock Edge Rate, Measured from 20% to 80% of V_{DD} , CLOAD = 15 pF See Figure 3.	0.8	1.4	-	V/ns
ER _{OF}	Falling Edge Rate -01	Output Clock Edge Rate, Measured from 80% to 20% of V_{DD} , CLOAD = 15 pF See Figure 3.	0.8	1.4	-	V/ns
ER _{OR}	Rising Edge Rate -04	Output Clock Edge Rate, Measured from 20% to 80% of V_{DD} , CLOAD = 15 pF See Figure 3.	0.7	1.1	-	V/ns
ER _{OF}	Falling Edge Rate -04	Output Clock Edge Rate, Measured from 80% to 20% of V_{DD} , CLOAD = 15 pF See Figure 3.	0.7	1.1	-	V/ns
t_9	Clock Jitter	Peak-to-peak period jitter	-	-	100	ps
t_{10}	PLL Lock Time		-	-	3	ms

Test and Measurement Setup



Voltage and Timing Definitions

Figure 2. Duty Cycle Definition

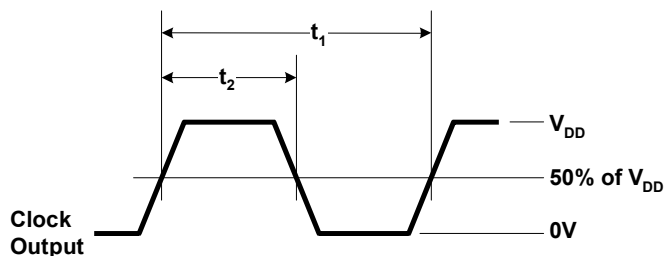
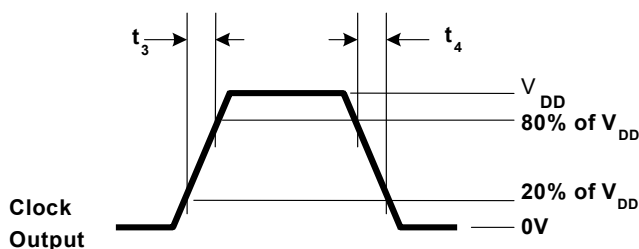


Figure 3. $ER = (0.6 \times V_{DD})/t_3$, $EF = (0.6 \times V_{DD})/t_4$



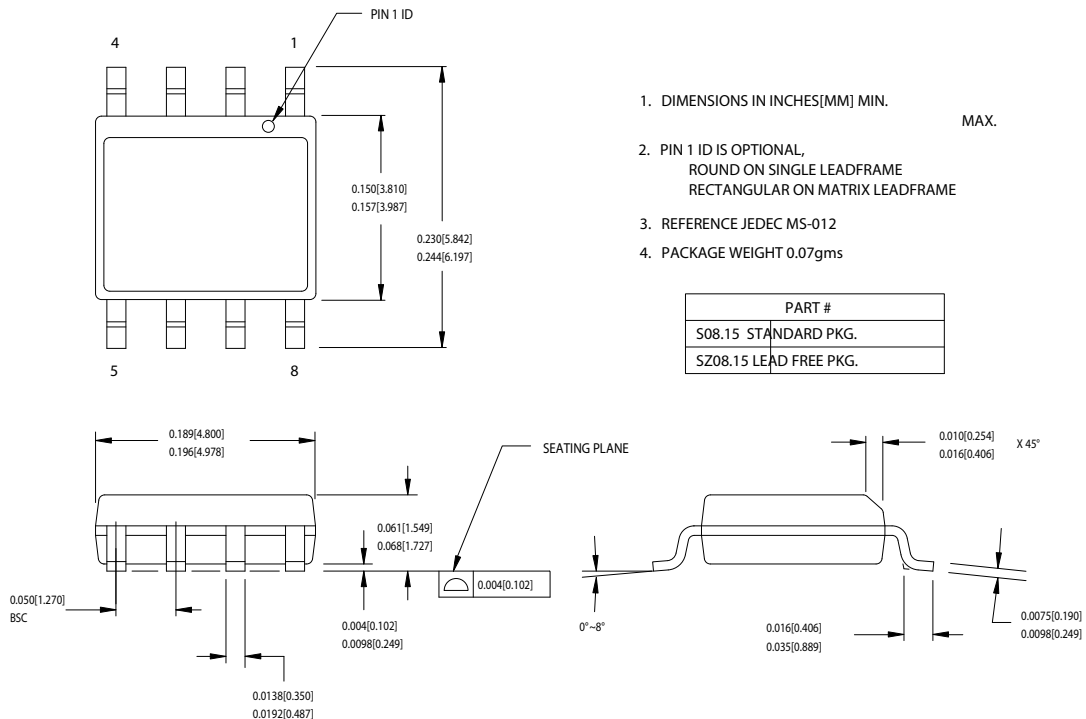
Note
3. Not 100% tested.

Ordering Information

Ordering Code	Package Type	Operating Range	Operating Voltage	Features
CY241V08ASC-01	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve
CY241V08ASC-01T	8-pin SOIC –Tape and Reel	Commercial	3.3V	Linear VCXO control curve
CY241V08ASC-04	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve
CY241V08ASC-04T	8-pin SOIC –Tape and Reel	Commercial	3.3V	Linear VCXO control curve
Pb-free				
CY241V8ASXC-01	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve
CY241V8ASXC-01T	8-pin SOIC –Tape and Reel	Commercial	3.3V	Linear VCXO control curve
Pure Sn				
CY241V8ASXC-1S	8-pin SOIC	Commercial	3.3V	Linear VCXO control curve
CY241V8ASXC-1ST	8-pin SOIC –Tape and Reel	Commercial	3.3V	Linear VCXO control curve

Package Drawing and Dimensions

Figure 4. 8-Pin (150-Mil) SOIC



51-85066-°C

Document History Page

Document Title: CY241V08A-01,04/CY241V8A-01MPEG Clock Generator with VCXO				
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REV.	ECN NO.	Submission Date	Orig. of Change	Description of Change
**	214069	See ECN	RGL	New Data Sheet
*A	220404	See ECN	RGL	Minor Change: To post on web
*B	393122	See ECN	RGL	Added Lead-free device for -01 Added the CY241V8A-01 in the title
*C	414184	See ECN	RGL	Minor Change: Deleted unnecessary text in the benefit section
*D	455059	See ECN	RGL	Added Pure Sn parts for -01
*E	2759384	09/02/2009	TSAI	Updated template Post to external web

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